

**AP7354** 

#### 150mA ULTRA-LOW QUIESCENT CURRENT LDO WITH ENABLE

#### **Description**

The AP7354 is a low dropout regulator with high output voltage accuracy. The AP7354 includes a voltage reference, error amplifier, current limit circuit, and an enable input to turn it on/off. With the integrated resistor network, fixed output voltage versions can be delivered.

With its ultra-low guiescent current, the AP7354 is well-suited for lowpower handheld, wearable devices, and other battery-operated devices requiring an extended time period until new battery replacement.

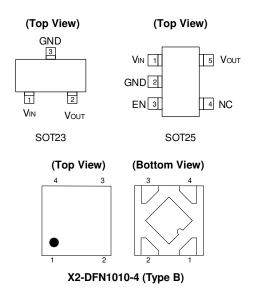
The AP7354 is available in SOT23, SOT25, and X2-DFN1010-4 (Type B) packages.

#### **Features**

- Wide VIN Range: 2.0V to 5.5V
- Guarantee Output Current: 150mA
- Output Voltage Range: 1.1V to 4.5V
- Vour Accuracy: ±1%
- Quiescent Current as Low as 0.25µA
- Output Discharge Available for Devices in SOT25 or X2-DFN1010-4 (Type B)
- Typical Standby Current: 0.02µA
- ESD Protection Exceeds JESD 22
  - Exceeds 4000V Human Body Model (A114)
  - Exceeds 400V Machine Model (A115)
- Latch-Up Exceeds 400mA per JESD 78, Class I
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals:
  - SOT23/SOT25: Finish Mate Tin Plated Leads, Solderable per MIL-STD-202, Method 208@3)
  - X2-DFN1010-4 (Type B): Finish NiPdAu over Copper Leads, Solderable per MIL-STD-202, Method 208@4)
- Weight:
  - SOT23: 0.009 grams (Approximate)
  - SOT25: 0.016 grams (Approximate)
  - X2-DFN1010-4 (Type B): 0.001 grams (Approximate)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

#### **Pin Assignments**

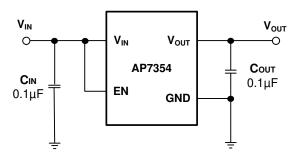


Pin 1 – V<sub>OUT</sub>, Pin 2 – GND, Pin 3 – EN, Pin 4 – V<sub>IN</sub>

## **Applications**

- Wearable Electronics
- Sensor Module for Internet-of-Things (IoT)
- Wireless Communication Module
- **Battery-Operated Device**
- Camera
- Image Sensor

## **Typical Applications Circuit** (Note 4)



1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. Notes:

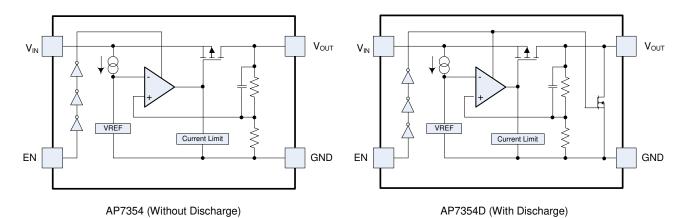
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. X5R- and X7R-type capacitors are suggested due to their minimal variation in value and ESR over temperature.



# **Pin Description**

	Pin Numbe	er			
SOT25	SOT23	X2-DFN1010-4 (Type B)	Pin Name	Function	
3	1	3	EN	Chip Enable — This should be driven either high or low and must not be floating. Driving EN high enables regulator output, while pulling it low places regulator into shutdown mode.	
2	3	2	GND	Ground	
5	2	1	V <sub>OUT</sub>	Output Voltage	
1	1	4	VIN	Power Input	
_	_	Center Pad	_	No connection or ground. Note: Chip Ground must be through GND pin.	

# **Functional Block Diagram**



EN Pin Not Available on SOT23



# **Absolute Maximum Ratings** (Note 5)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	4	kV
ESD MM	Machine Model ESD Protection	400	V
VIN	Input Voltage	6.0	V
V <sub>EN</sub>	Input Voltage at EN Pin	6.0	V
Vouт	Output Voltage to GND	-0.3 to V <sub>IN</sub> +0.3	V
TA	Operating Ambient Temperature	-40 to +85	°C
TJ	Maximum Junction Temperature	+125	°C
T <sub>STG</sub>	Storage Temperature	-55 to +125	°C
P <sub>D</sub>	Power Dissipation (Note 6)	315	mW

Notes:

# **Recommended Operating Conditions**

Symbol	Parameter	Min	Мах	Unit
VIN	Input Voltage	2.0	5.5	٧
lout	Output Current	0	150	mA
TA	Operating Ambient Temperature	-40	+85	°C

<sup>5.</sup> Stresses beyond those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods can affect device reliability.

<sup>6.</sup> This is based on an application temperature of +40°C. Derate 3.75mW per °C for each degree above +40°C.



 $\textbf{Electrical Characteristics} \hspace{0.2cm} \textbf{(@TA = +25°C, V_{EN} = V_{IN} = V_{OUT} + 1V (1.5V < V_{OUT} \leq 4.5V), V_{EN} = V_{IN} = 2.5V (V_{OUT} \leq 1.5V), I_{OUT} = 1mA, I_$  $C_{IN} = C_{OUT} = 0.1 \mu F$ , unless otherwise specified.)

Parameter		Conditions	Min	Тур	Max	Unit	
Input Voltage	T <sub>A</sub> = -40°C to +85°C		2.0	_	5.5	V	
	V <sub>OUT</sub> > 2.0V	T <sub>A</sub> = +25°C	-1	_	+1	21	
0.1.11/11	I <sub>OUT</sub> = 1mA	$T_A = -40$ °C to $+85$ °C	-2	_	+2	%	
Output Voltage Accuracy	V <sub>OUT</sub> ≤ 2.0V	T <sub>A</sub> = +25°C	-40	_	40		
	Iout = 1mA	$T_A = -40$ °C to $+85$ °C	-80	_	80	mV	
Line Regulation (ΔV <sub>OUT</sub> /ΔV <sub>IN</sub> /V <sub>OUT</sub> )	MAX (V <sub>OUT</sub> + 1.0V (All Versions Exce	$(2.5V) \le V_{IN} \le 5.5V$ upt 4.5V)	_	0.02	0.1	%/V	
Load Dogulation (AVa.)	1mA ≤ I <sub>OUT</sub> ≤ 150r	mA (All Versions Except 4.5V)	-40	_	40	mV	
Load Regulation (ΔV <sub>OUT</sub> )	1mA ≤ I <sub>OUT</sub> ≤ 150r	mA (Applicable to 4.5V Version)	-55	_	55	mV	
Short Circuit Current Limit (Note 7)	Vout = 0V		_	60	_	mA	
Quiescent Current (Note 8)	I <sub>OUT</sub> = 0mA		_	0.25	0.6	μΑ	
Istandby	Set EN Low, No Lo	oad	_	0.02	0.2	μΑ	
Output Current	_		150	_	_	mA	
		V <sub>OUT</sub> = 1.1V	_	0.70	1.00	>	
		V <sub>OUT</sub> = 1.2V	_	0.60	0.90		
		V <sub>OUT</sub> = 1.5V	_	0.43	0.75		
	Iout = 150mA	V <sub>OUT</sub> = 1.8V	_	0.33	0.60		
		V <sub>OUT</sub> = 1.85V	_	0.32	0.58		
Dropout Voltage (Note 9)		V <sub>OUT</sub> = 2.2V	_	0.27	0.52		
		Vout = 2.5V	_	0.22	0.48		
		Vout = 2.8V	_	0.19	0.40		
		Vout = 3.0V	_	0.18	0.35		
		V <sub>OUT</sub> = 3.3V	_	0.16	0.35		
		V <sub>OUT</sub> = 4.5V	_	0.14	0.35		
EN Input Low Voltage	_		_	_	0.4	V	
EN Input High Voltage	_		1.0	_	5.5	V	
Active Output Discharge Resistance (Note 10)	VIN = 4.0V, VEN =	0V	_	35	_	Ω	
		SOT23		170	_		
OJA Thermal Resistance Junction-to-Ambient		SOT25		162	_	°C/W	
		X2-DFN1010-4 (Type B)	_	295	_		
		SOT23	_	43	_		
Θ <sub>JC</sub> Thermal Resistance Junction-to-Case	(Note 11)	SOT25	_	38	_	°C/W	
		X2-DFN1010-4 (Type B)	_	120	_		

Notes:

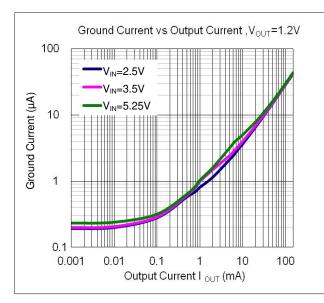
- 7. Short-circuit current is measured with  $V_{\text{OUT}}$  pulled to GND.
- 8. Quiescent current defined as the difference in current between the input and the output.
- 9. Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.

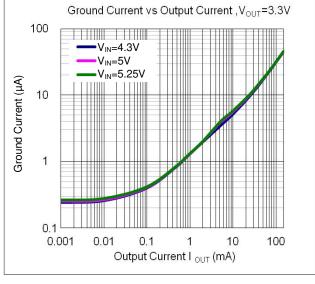
  10. AP7354 is available with two options: built-in discharge (AP7354D) and non-discharge (AP7354).

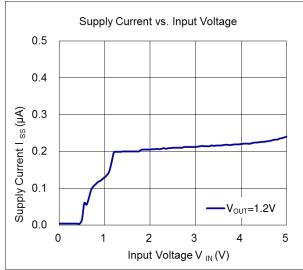
  11. Test condition: Device mounted on 1" × 1" FR-4 MRP substrate PCB, 2oz copper, with minimum recommended pad layout.

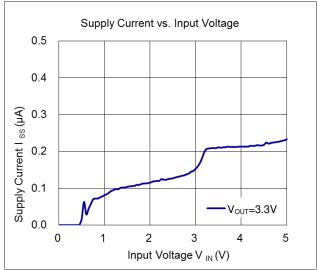


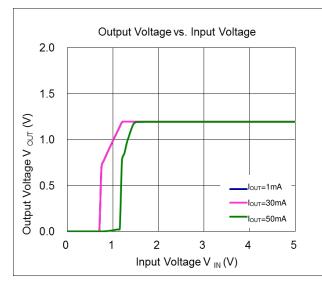
#### **Performance Characteristics**

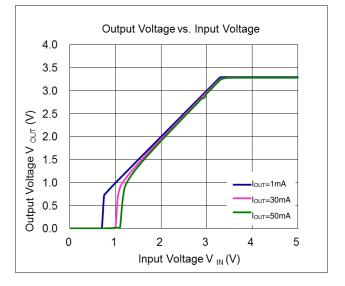




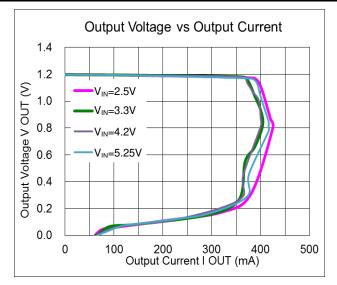


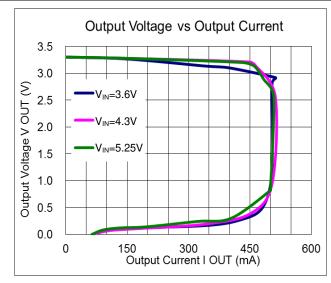


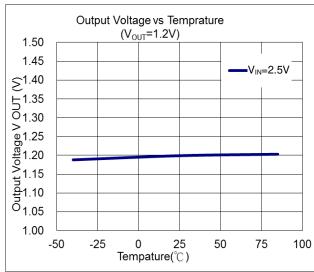


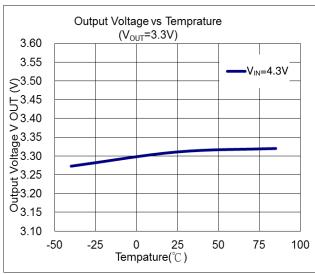


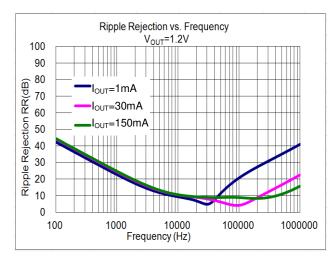


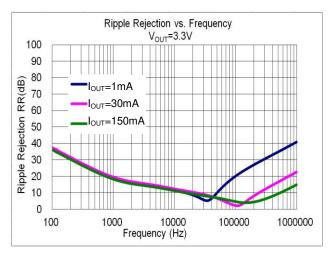






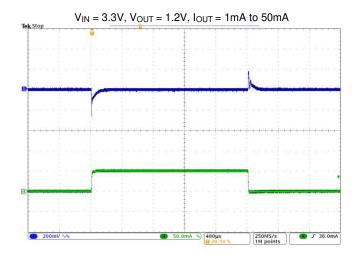


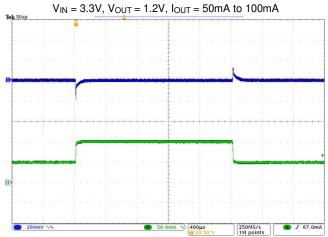


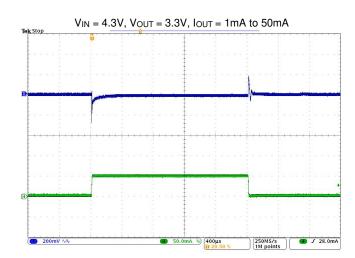


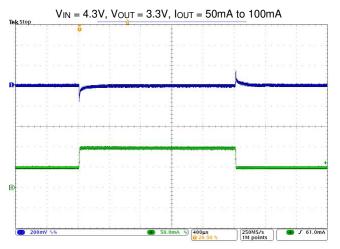


Load Transient Response ( $C_{IN} = C_{OUT} = 0.1 \mu F$ ,  $t_R = t_F = 5.0 \mu s$ , unless otherwise specified.)







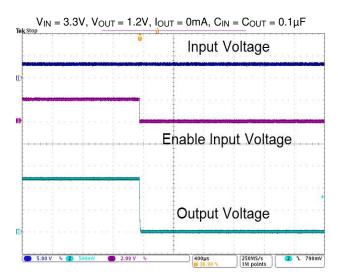


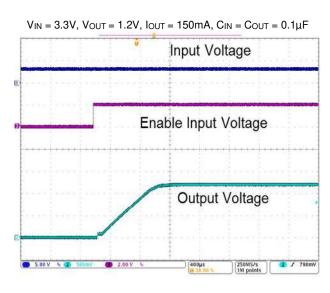


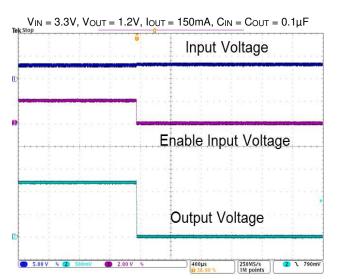
#### **TURN ON**

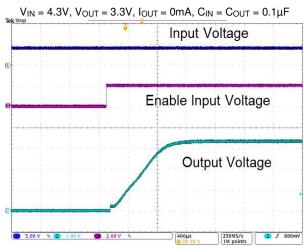
# V<sub>IN</sub> = 3.3V, V<sub>OUT</sub> = 1.2V, I<sub>OUT</sub> = 0mA, C<sub>IN</sub> = C<sub>OUT</sub> = 0.1μF Input Voltage Enable Input Voltage

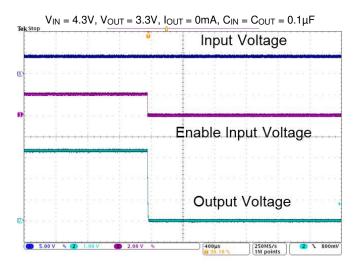
#### **TURN OFF**









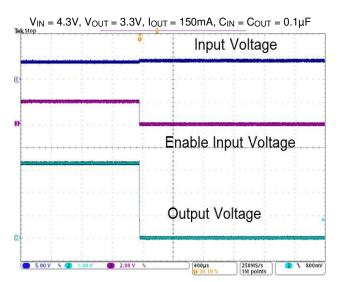




#### **TURN ON**

# V<sub>IN</sub> = 4.3V, V<sub>OUT</sub> = 3.3V, I<sub>OUT</sub> = 150mA, C<sub>IN</sub> = C<sub>OUT</sub> = 0.1μF Input Voltage Enable Input Voltage Output Voltage

#### **TURN OFF**





#### **Application Information**

#### **Output Capacitor**

An output capacitor (C<sub>OUT</sub>) is required to improve transient response and maintain stability. The AP7354 is stable with very small ceramic output capacitors. The equivalent series resistance (ESR) and capacitance drive the selection. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the GND pin. Care must be taken to reduce the impedance in the layout.

#### **Input Capacitor**

To prevent the input voltage from dropping during load steps, it is recommended to utilize an input capacitor ( $C_{IN}$ ). A minimum  $0.1\mu F$  ceramic capacitor is recommended between  $V_{IN}$  and GND pin to decouple input power supply glitch. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both  $V_{IN}$  and GND pin.

#### **Enable Control**

The AP7354 is turned on by setting the EN pin high, and is turned off by pulling them low. If this feature is not used, the EN pin should be tied to V<sub>IN</sub> pin to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pin must be able to swing above and below the specified turn-on/off voltage thresholds listed in the *Electrical Characteristics* section.

#### **Layout Considerations**

For good ground loop and stability, the input and output capacitors must be located close to the input, output, and GND pin of the device. The regulator GND pin must be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance. Wide trace must be used for large current paths from VIN to VOUT and load circuit.

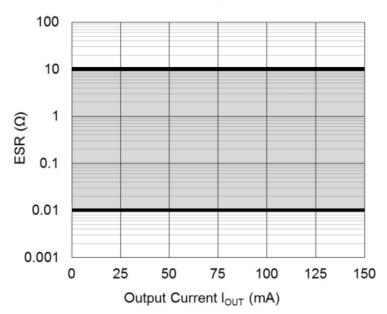
#### **ESR vs. Output Current**

A ceramic type output capacitor is recommended for this series; however, the other output capacitors with low ESR also can be used. The relations between IouT (output current) and ESR of an output capacitor are shown below. The stable region is marked as the hatched area in the graph.

#### Measurement Conditions:

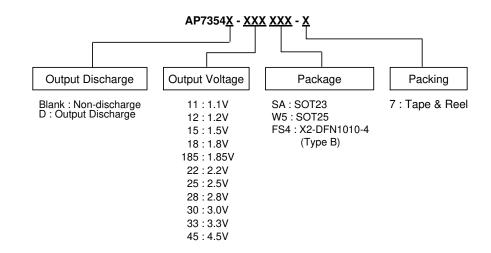
Frequency Band: 10Hz to 2MHz
 Temperature: -40°C to +85°C

# ESR vs. Output Current





# Ordering Information (Note 12)



	00700	SOT25	SOT25	7" Tape and Reel		
Output Voltage	SOT23	Without Discharge	With Discharge	Quantity	Part Number Suffix	
1.2	AP7354-12SA-7	AP7354-12W5-7	AP7354D-12W5-7	3000/Tape & Reel	-7	
1.5	AP7354-15SA-7	AP7354-15W5-7	AP7354D-15W5-7	3000/Tape & Reel	-7	
1.8	AP7354-18SA-7	AP7354-18W5-7	AP7354D-18W5-7	3000/Tape & Reel	-7	
1.85	AP7354-185SA-7	AP7354-185W5-7	AP7354D-185W5-7	3000/Tape & Reel	-7	
2.2	AP7354-22SA-7	_	_	3000/Tape & Reel	-7	
2.5	AP7354-25SA-7	AP7354-25W5-7	AP7354D-25W5-7	3000/Tape & Reel	-7	
2.8	AP7354-28SA-7	AP7354-28W5-7	AP7354D-28W5-7	3000/Tape & Reel	-7	
3.0	AP7354-30SA-7	AP7354-30W5-7	AP7354D-30W5-7	3000/Tape & Reel	-7	
3.3	AP7354-33SA-7	AP7354-33W5-7	AP7354D-33W5-7	3000/Tape & Reel	-7	
4.5	AP7354-45SA-7	AP7354-45W5-7	AP7354D-45W5-7	3000/Tape & Reel	-7	

Output	X2-DFN1010-4 (Type B)	X2-DFN1010-4 (Type B)	7" Tape	7" Tape and Reel	
Voltage	Without Discharge	With Discharge	Quantity	Part Number Suffix	
1.1	AP7354-11FS4-7	AP7354D-11FS4-7	5000/Tape & Reel	-7	
1.2	AP7354-12FS4-7	AP7354D-12FS4-7	5000/Tape & Reel	-7	
1.5	AP7354-15FS4-7	AP7354D-15FS4-7	5000/Tape & Reel	-7	
1.8	AP7354-18FS4-7	AP7354D-18FS4-7	5000/Tape & Reel	-7	
1.85	AP7354-185FS4-7	AP7354D-185FS4-7	5000/Tape & Reel	-7	
2.5	AP7354-25FS4-7	AP7354D-25FS4-7	5000/Tape & Reel	-7	
2.8	AP7354-28FS4-7	AP7354D-28FS4-7	5000/Tape & Reel	-7	
3.0	AP7354-30FS4-7	AP7354D-30FS4-7	5000/Tape & Reel	-7	
3.3	AP7354-33FS4-7	AP7354D-33FS4-7	5000/Tape & Reel	-7	
4.5	AP7354-45FS4-7	AP7354D-45FS4-7	5000/Tape & Reel	-7	

Note: 12. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



# **Marking Information**

(1) SOT23

(Top View)

3

 $\underline{\mathsf{XXX}}$ 2 XXX: Identification Code

Y : Year 0 to 9

 $\overline{\underline{W}}$ : Week : A to Z : 1 to 26 week;

a to z : 27 to 52 week; z represents 52 and 53 week

X: Internal Code

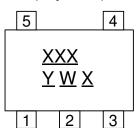
Part Number	Package	Identification Code
AP7354-12SA-7	SOT23	A8A
AP7354-15SA-7	SOT23	A8B
AP7354-18SA-7	SOT23	A8C
AP7354-185SA-7	SOT23	A8D
AP7354-22SA-7	SOT23	A8K
AP7354-25SA-7	SOT23	A8E
AP7354-28SA-7	SOT23	A8F
AP7354-30SA-7	SOT23	A8G
AP7354-33SA-7	SOT23	A8H
AP7354-45SA-7	SOT23	A8J



# Marking Information (continued)

#### (2) SOT25

# (Top View)



XXX: Identification Code

Y: Year 0 to 9

 $\underline{W}$ : Week: A to Z: 1 to 26 week;

a to z : 27 to 52 week; z represents 52 and 53 week

X: Internal Code

Part Number	Package	Identification Code
AP7354-12W5-7	SOT25	A8A
AP7354-15W5-7	SOT25	A8B
AP7354-18W5-7	SOT25	A8C
AP7354-185W5-7	SOT25	A8D
AP7354-25W5-7	SOT25	A8E
AP7354-28W5-7	SOT25	A8F
AP7354-30W5-7	SOT25	A8G
AP7354-33W5-7	SOT25	A8H
AP7354-45W5-7	SOT25	A8J
AP7354D-12W5-7	SOT25	A9A
AP7354D-15W5-7	SOT25	A9B
AP7354D-18W5-7	SOT25	A9C
AP7354D-185W5-7	SOT25	A9D
AP7354D-25W5-7	SOT25	A9E
AP7354D-28W5-7	SOT25	A9F
AP7354D-30W5-7	SOT25	A9G
AP7354D-33W5-7	SOT25	А9Н
AP7354D-45W5-7	SOT25	A9J



# Marking Information (continued)

#### (3) X2-DFN1010-4 (Type B)

(Top View)

<u>XXX</u> <u>Y W X</u> XXX: Identification Code

Y: Year: 0~9

<u>W</u>: Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents 52 and 53 week

52 and 53 week X: Internal Code

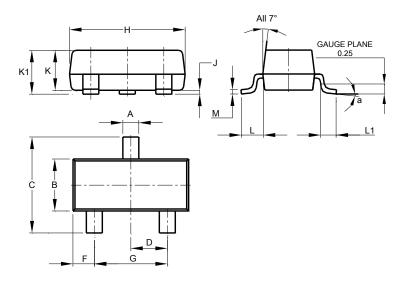
Part Number	V <sub>OUT</sub>	Package	Identification Code
AP7354-11FS4-7	1.1V	X2-DFN1010-4 (Type B)	A8M
AP7354-12FS4-7	1.2V	X2-DFN1010-4 (Type B)	A8A
AP7354-15FS4-7	1.5V	X2-DFN1010-4 (Type B)	A8B
AP7354-18FS4-7	1.8V	X2-DFN1010-4 (Type B)	A8C
AP7354-185FS4-7	1.85V	X2-DFN1010-4 (Type B)	A8D
AP7354-25FS4-7	2.5V	X2-DFN1010-4 (Type B)	A8E
AP7354-28FS4-7	2.8V	X2-DFN1010-4 (Type B)	A8F
AP7354-30FS4-7	3.0V	X2-DFN1010-4 (Type B)	A8G
AP7354-33FS4-7	3.3V	X2-DFN1010-4 (Type B)	A8H
AP7354-45FS4-7	4.5V	X2-DFN1010-4 (Type B)	A8J
AP7354D-11FS4-7	1.1V	X2-DFN1010-4 (Type B)	A9M
AP7354D-12FS4-7	1.2V	X2-DFN1010-4 (Type B)	A9A
AP7354D-15FS4-7	1.5V	X2-DFN1010-4 (Type B)	A9B
AP7354D-18FS4-7	1.8V	X2-DFN1010-4 (Type B)	A9C
AP7354D-185FS4-7	1.85V	X2-DFN1010-4 (Type B)	A9D
AP7354D-25FS4-7	2.5V	X2-DFN1010-4 (Type B)	A9E
AP7354D-28FS4-7	2.8V	X2-DFN1010-4 (Type B)	A9F
AP7354D-30FS4-7	3.0V	X2-DFN1010-4 (Type B)	A9G
AP7354D-33FS4-7	3.3V	X2-DFN1010-4 (Type B)	А9Н
AP7354D-45FS4-7	4.5V	X2-DFN1010-4 (Type B)	A9J



# **Package Outline Dimensions**

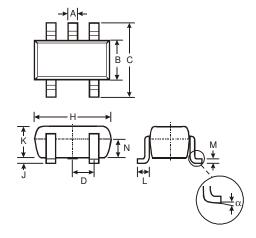
 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

#### (1) Package Type: SOT23



0.0700					
	SO	T23			
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
C	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
H	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	0°	8°			
All	Dimens	ions in	mm		

#### (2) Package Type: SOT25



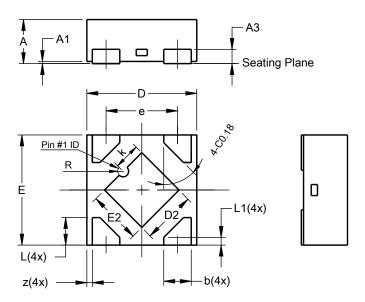
SOT25					
Dim	Min	Max	Тур		
Α	0.35	0.50	0.38		
В	1.50	1.70	1.60		
ပ	2.70	3.00	2.80		
D	-	-	0.95		
Н	2.90	3.10	3.00		
7	0.013	0.10	0.05		
K	1.00	1.30	1.10		
Г	0.35	0.55	0.40		
Μ	0.10	0.20	0.15		
N	0.70	0.80	0.75		
α	0°	8°	-		
All D	imensi	ons in	mm		



# Package Outline Dimensions (continued)

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### (3) Package Type: X2-DFN1010-4 (Type B)

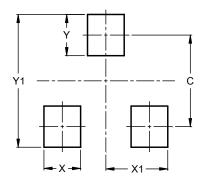


X2-	X2-DFN1010-4 (Type B)					
Dim	Min	Max	Тур			
Α	-	0.40	0.39			
<b>A</b> 1	0.00	0.05	0.02			
A3	-	-	0.13			
b	0.20	0.30	0.25			
D	0.95	1.05	1.00			
D2	0.43	0.53	0.48			
Е	0.95	1.05	1.00			
E2	0.43	0.53	0.48			
е	-	-	0.65			
k	0.19	0.29	0.24			
L	0.20	0.30	0.25			
L1	0.02	0.12	0.07			
R	0.02	0.08	0.05			
Z	-	-	0.050			
All	All Dimensions in mm					

# **Suggested Pad Layout**

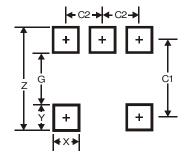
Please see http://www.diodes.com/package-outlines.html for the latest version.

#### (1) Package Type: SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Υ	0.9
V1	29

#### (2) Package Type: SOT25



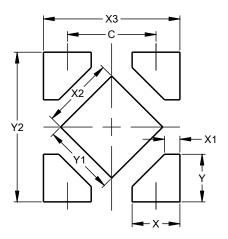
Dimensions	Value
Z	3.20
G	1.60
Х	0.55
Υ	0.80
C1	2.40
C2	0.95



# Suggested Pad Layout (continued)

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### (3) Package Type: X2-DFN1010-4 (Type B)



Dimensions	Value (in mm)
С	0.650
X	0.350
X1	0.112
X2	0.530
Х3	1.00
Υ	0.350
Y1	0.530
Y2	1.100



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